

MFE211-MFE212

High-reliability discrete products and engineering services since 1977

### **DUAL GATE MOSFETS**

#### **FEATURES**

- Available as "HR" (high reliability) screened per MIL-PRF-19500, JANTX level. Add "HR" suffix to base part number.
- Available as non-RoHS (Sn/Pb plating), standard, and as RoHS by adding "-PBF" suffix.

#### **MAXIMUM RATINGS.**

Rating	Symbol	Value	Unit	
Drain Source Voltage	V <sub>DSX</sub>	20	Vdc	
Drain Gate Voltage	$V_{DG1}$	35	Vdc	
Drain Gate voltage	$V_{DG2}$	35	Vuc	
Gate Current	I <sub>G1</sub>	±10	mAdc	
date current	I <sub>G2</sub>	±10		
Drain Current – Continuous	I <sub>D</sub>	50	mAdc	
Total Power Dissipation @ T <sub>A</sub> = 25°C	D	360	mW	
Derate above 25°C	$P_D$	2.4	mW/°C	
Total Power Dissipation @ T <sub>c</sub> = 25°C	D	1.2	Watt	
Derate above 25°C	$P_{D}$	8.0	mW/°C	
Storage Channel Temperature Range	$T_{stg}$	-65 to +200	°C	
Junction Temperature Range	T <sub>J</sub>	-65 to +175	°C	
Lead Temperature, 1/16" from Seated Surface for 10 Seconds	Τ <sub>L</sub>	300	°C	

### **ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> = 25°C unless otherwise noted)

Characteristics		Symbol	Min	Max	Unit
OFF CHARACTERISTICS					
Drain Source Breakdown Voltage		$V_{(BR)DSX}$	20	-	Vdc
$(I_D = 10 \mu Adc, V_{G1S} = V_{G2S} = -4.0 Vdc)$			20		
Gate 1 – Source Breakdown Voltage (1)		V <sub>(BR)G1SO</sub>		-	Vdc
$(I_{G1} = \pm 10 \text{ mAdc}, V_{G2S} = V_{DS} = 0)$			±6.0		
Gate 2 – Source Breakdown Voltage (1)			16.0		
$(I_{G2} = \pm 10 \text{ mAdc}, V_{G1S} = V_{DS} = 0)$		V <sub>(BR)G2SO</sub>	±6.0	-	Vdc
Gate 1 to Source Cutoff Voltage	MFE211	V	-0.5	-5.5	\/de
( $V_{DS}$ = 15 Vdc, $V_{G2S}$ = 4.0 Vdc, $I_D$ = 20 $\mu$ Adc)	MFE212	$V_{G1S(off)}$	-0.5	-4.0	Vdc
Gate 2 to Source Cutoff Voltage	MFE211	.,	-0.2	-2.5	
$(V_{DS} = 15 \text{ Vdc}, V_{G1S} = 0, I_D = 20 \mu\text{Adc})$	MFE212	V <sub>G2S(off)</sub>	-0.2	-4.0	Vdc
Gate 1 Leakage Current					
$(V_{G1S} = \pm 5.0 \text{ Vdc}, V_{G2S} = V_{DS} = 0)$		I <sub>G1SS</sub>	-	±10	mAdc
$(V_{G1S} = -5.0 \text{ Vdc}, V_{G2S} = V_{DS} = 0, T_A = 150^{\circ}\text{C})$			-	-10	μAdc
Gate 2 Leakage Current					
$(V_{G2S} = \pm 5.0 \text{ Vdc}, V_{G1S} = V_{DS} = 0)$		I <sub>G2SS</sub>	-	±10	nAdc
$(V_{G2S} = -5.0 \text{ Vdc}, V_{G1S} = V_{DS} = 0, T_A = 150^{\circ}\text{C})$			-	-10	μAdc
ON CHARACTERISTICS					
Zero-Gate Voltage Drain Current (2)		I <sub>DSS</sub>	6.0	40	mAdc
$(V_{DS} = 15 \text{ Vdc}, V_{G1S} = 0, V_{G2S} = 4.0 \text{ Vdc})$					
SMALL SIGNAL CHARACTERISTICS					
Forward Transfer Admittance (3)		Y <sub>fs</sub>	17	40	
$(V_{DS} = 15 \text{ Vdc}, V_{G2S} = 4.0 \text{ Vdc}, V_{G1S} = 0, f = 1.0 \text{ kHz})$					mmhos
Reverse Transfer Capacitance		C <sub>rss</sub>	0.005	0.05	
$(V_{DS} = 15 \text{ Vdc}, V_{G2S} = 4.0 \text{ Vdc}, I_D = 10 \text{ mAdc}, f = 1.0 \text{ MHz})$					pF



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# MFE211-MFE212

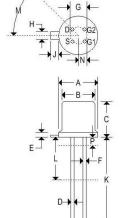
### **DUAL GATE MOSFETS**

FUNCTIONAL CHARACTERISTICS					
Noise Figure					
$(V_{DD} = 18 \text{ Vdc}, V_{GG} = 7.0 \text{ Vdc}, f = 200 \text{ MHz})$	MFE211	NF	-	3.5	dB
$(V_{DD} = 24 \text{ Vdc}, V_{GG} = 6.0 \text{ Vdc}, f = 45 \text{ MHz})$	MFE212		-	4.0	
Common Source Power Gain					
$(V_{DD} = 18 \text{ Vdc}, V_{GG} = 7.0 \text{ Vdc}, f = 200 \text{ MHz})$	MFE211	$G_{ps}$	24	35	dB
$(V_{DD} = 18 \text{ Vdc}, V_{GG} = 6.0 \text{ Vdc}, f = 45 \text{ MHz})$	MFE211	G <sub>c</sub> <sup>(5)</sup>	29	37	ив
$(V_{DD} = 18 \text{ Vdc}, f_{LO} = 245 \text{ MHz}, f_{RF} = 200 \text{ MHz})$	MFE212	G <sub>c</sub> ,	21	28	
Bandwidth					
$(V_{DD} = 18 \text{ Vdc}, V_{GG} = 7.0 \text{ Vdc}, f = 200 \text{ MHz})$	MFE211	BW	5.0	12	NALL-
$(V_{DD} = 18 \text{ Vdc}, f_{LO} = 245 \text{ MHz}, f_{RF} = 200 \text{ MHz})$	MFE212		4.0	7.0	MHz
$(V_{DD} = 18 \text{ Vdc}, V_{GG} = 6.0 \text{ Vdc}, f = 45 \text{ MHz})$	MFE211		3.5	6.0	
Gain Control Gate Supply Voltage (4)					
$(V_{DD} = 18 \text{ Vdc}, \Delta G_{ps} = -30 \text{ dB}, f = 200 \text{ MHz})$	MFE211	$V_{GG(GC)}$	-	-2.0	Vdc
( $V_{DD}$ = 18 Vdc, $\Delta G_{ps}$ = -30 dB, f = 45 MHz)	MFE211		-	±1.0	

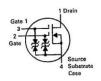
- All gate breakdown voltages are measured while the device is conducting rated gate current. This ensures that the gate voltage limiting network is functioning properly.
- Pulse test: Pulse width =  $300\mu$ s, duty cycle  $\leq 2\%$ .
- This parameter must be measured with bias voltages applied for less than 5 seconds to avoid overheating. The signal is applied to gate 1 with gate 2 at ac ground.
- $\Delta$  G<sub>ps</sub> is defined as the change in G<sub>ps</sub> from the value at  $V_{GG} = 7.0$  volts (MFE211). Power Gain Conversion. Amplitude at input from local oscillator is adjusted for maximum G<sub>C</sub>.

#### **MECHANICAL CHARACTERISTICS**

Case:	TO-72
Marking:	Alpha-numeric
Pin out:	See below



	TO-72					
	Inc	hes	Millimeters			
	Min	Max	Min	Max		
Α	-	0.230		5.840		
В	-	0.195	-	4.950		
С	4	0.210	-	5.330		
D		0.021	380	0.530		
E	-	0.030	-	0.760		
F	150	0.019	(8)	0.480		
G	0.100	BSC	2.540 BSC			
Н	-	0.046		1.170		
J	140	0.048	(4)	1.220		
K	0.500	-	12.700	9.0		
L	0.250		*	6.350		
M	45° BSC		45° BSC			
N	0.050 BDC		1.270 BSC			
Р	- 2	0.050	(4)	1.270		

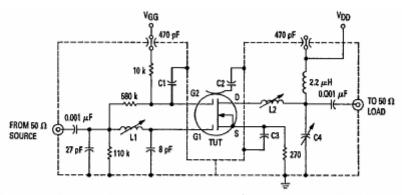




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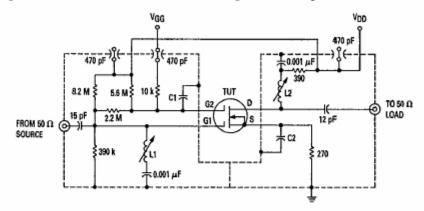
# MFE211-MFE212

### **DUAL GATE MOSFETS**



C1, C2 & C3: Leadless disc ceramic, 0,001 µF C4: ARCO 462, 5-80 pF, or equivalent L1: 3 Turns #18, 3/16" diameter aluminum slug L2: 8 Turns #20, 3/16" diameter aluminum slug

Figure 1. 200 MHz Power Gain, Gain Control Voltage, and Noise Figure Test Circuit for MFE211



C1: Leadless disc ceramic, 0.001  $\mu F$  C2: Leadless disc ceramic, 0.01  $\mu F$ 

L1: 8 Turns #28, 5/32" diameter form, type "J" slug L2: 9 Turns #28, 5/32" diameter form, type "J" slug

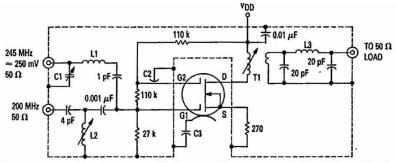
Figure 2. 45 MHz Power Gain and Noise Figure Test Circuit for MFE211



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### MFE211-MFE212

**DUAL GATE MOSFETS** 



L1: 7 Turns #34, 1/4" diameter aluminum slug L2: 5-1/2 Turns #20, 1/4" diameter aluminum slug L3: 7 Turns #24, 1/4" diameter air core C1: Arco type 462, 5–80 pF C2: 0.001 µF leadless disc C3: 0.01 µF leadless disc T1: Pri: 25 Turns #30, close wound on 1/4" diameter form, type "J" slug Sec: 4 Turns #30, centered over primary

Figure 3. 200 MHz-to-45 MHz Circuit for Conversion Power Gain for MFE212

#### TYPICAL CHARACTERISTICS

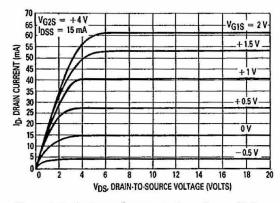


Figure 4. Drain Current versus Drain-to-Source Voltage

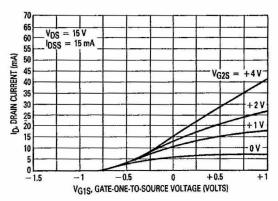


Figure 5. Drain Current versus Gate-One-to-Source Voltage

#### SMALL-SIGNAL COMMON-SOURCE PARAMETER

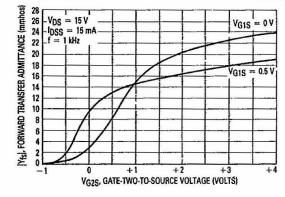


Figure 6. Forward Transfer Admittance versus Gate-Two-to-Source Voltage

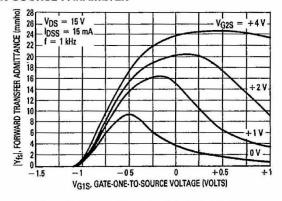


Figure 7. Forward Transfer Admittance versus Gate-One-to-Source Voltage



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### MFE211-MFE212

**DUAL GATE MOSFETS** 

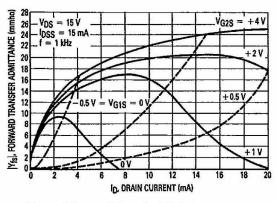


Figure 8. Forward Transfer Admittance versus

Drain Current

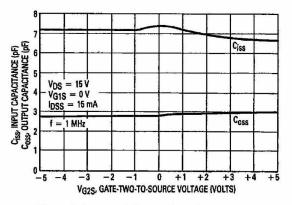


Figure 9. Input and Output Capacitance versus Gate-Two-to-Source Voltage

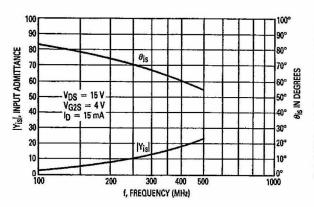


Figure 10. Small-Signal Gate-One Input Admittance versus Frequency

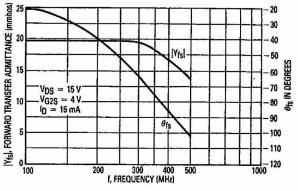


Figure 11. Small-Signal Forward Transfer Admittance versus Frequency

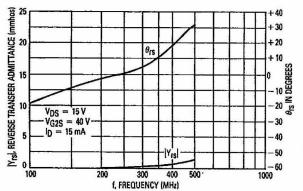


Figure 12. Small-Signal Gate-One Reverse Transfer Admittance versus Frequency

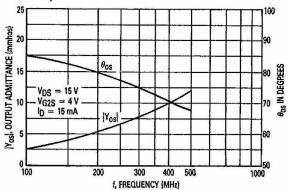


Figure 13. Small-Signal Gate-One Output Admittance versus Frequency



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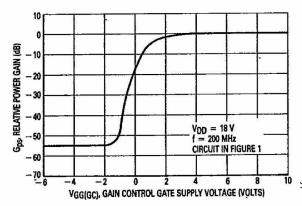


Figure 14. Relative Small-Signal Power Gain versus **Gain Control Gate Supply Voltage MFE211** 

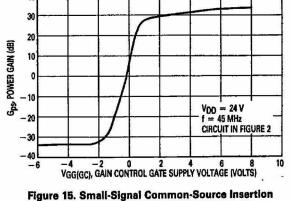


Figure 15. Small-Signal Common-Source Insertion Power Gain versus Gain Control Gate Supply Voltage

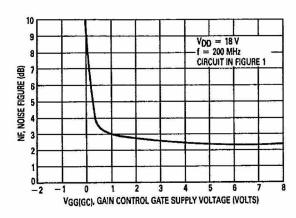


Figure 16. Common Source Spot Noise Figure versus **Gain Control Gate Supply Voltage** 

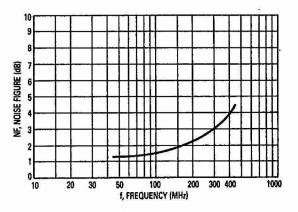


Figure 17. Optimum Spot Noise Figure versus Frequency